



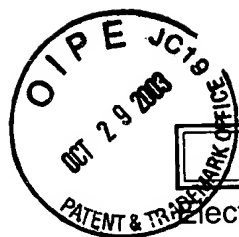
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Electronic Patent Application Submission
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Application ID: 09912844
Title of Invention: HIGH PRESSURE PROCESSING
CHAMBER FOR SEMICONDUCTOR
SUBSTRATE
First Named Inventor: Maximilian Biberger
Domestic/Foreign Application: Domestic Application
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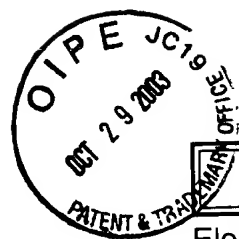
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Title of Invention	HIGH PRESSURE PROCESSING CHAMBER FOR SEMICONDUCTOR SUBSTRATE									
<p>Application Number: 09/912844 </p> <p>Date: 2001-07-24</p> <p>First Named Applicant: Maximilian A. Biberger</p> <p>Confirmation Number: 5915</p> <p>Attorney Docket Number:</p>										
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<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>SSI00501C-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	SSI00501C-usidst.xml		us-ids.dtd		us-ids.xsl
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Comments										



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<div>Application Number: 09/912844</div> <div>Confirmation Number: 5915</div> <div>First Named Applicant: Maximilian Biberger</div> <div>Attorney Docket Number:</div> <div>Search string: (5900107 or 5904737 or 5932100 or 5934991 or 5981399 or 5989342 or 6005226 or 6017820 or 6029371 or 6037277 or 6053348 or 6056008 or 6077053 or 6082150 or 6085935 or 6097015 or 6128830 or 6145519 or 6159295 or 6164297 or 6203582 or 6216364 or 6239038 or 6241825 or 6251250 or 6277753 or 6286231 or 6305677 or 6334266 or 6344174 or 6388317 or 6389677 or 6418956 or 6436824 or 6454945 or 6464790).pn.</div> <div>US Patent Documents</div> <div>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</div> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>5900107</td><td>1999-05-04</td><td>Murphy et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>5904737</td><td>1999-05-18</td><td>Preston et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>3</td><td>5932100</td><td>1999-08-03</td><td>Yager et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>4</td><td>5934991</td><td>1999-08-10</td><td>Rush</td><td></td><td></td><td></td></tr><tr><td></td><td>5</td><td>5981399</td><td>1999-11-09</td><td>Kawamura et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>6</td><td>5989342</td><td>1999-11-23</td><td>Ikeda et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>7</td><td>6005226</td><td>1999-12-21</td><td>Aschner et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>8</td><td>6017820</td><td>2000-01-25</td><td>Ting et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>9</td><td>6029371</td><td>2000-02-29</td><td>Kamikawa et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>10</td><td>6037277</td><td>2000-03-14</td><td>Masakara et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>11</td><td>6053348</td><td>2000-04-25</td><td>Morch</td><td></td><td></td><td></td></tr><tr><td></td><td>12</td><td>6056008</td><td>2000-05-02</td><td>Adams et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>13</td><td>6077053</td><td>2000-06-20</td><td>Fujikawa et al.</td><td></td><td></td><td></td></tr></tbody></table>				init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass		1	5900107	1999-05-04	Murphy et al.					2	5904737	1999-05-18	Preston et al.					3	5932100	1999-08-03	Yager et al.					4	5934991	1999-08-10	Rush					5	5981399	1999-11-09	Kawamura et al.					6	5989342	1999-11-23	Ikeda et al.					7	6005226	1999-12-21	Aschner et al.					8	6017820	2000-01-25	Ting et al.					9	6029371	2000-02-29	Kamikawa et al.					10	6037277	2000-03-14	Masakara et al.					11	6053348	2000-04-25	Morch					12	6056008	2000-05-02	Adams et al.					13	6077053	2000-06-20	Fujikawa et al.			
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	14	6082150	2000-07-04	Stucker	
	15	6085935	2000-07-11	Malchow et al.	
	16	6097015	2000-08-01	McCullough et al.	
	17	6128830	2000-10-10	Bettcher et al.	
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	19	6159295	2000-12-12	Maskara et al.	
	20	6164297	2000-12-26	Kamikawa	
	21	6203582	2001-03-20	Berner et al.	B1
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	25	6251250	2001-06-26	Keigler	B1
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	28	6305677	2001-10-23	Lenz	B1
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	30	6344174	2002-02-05	Miller et al.	B1
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Remarks

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